

10 A - 410 V internally clamped IGBT**Features**

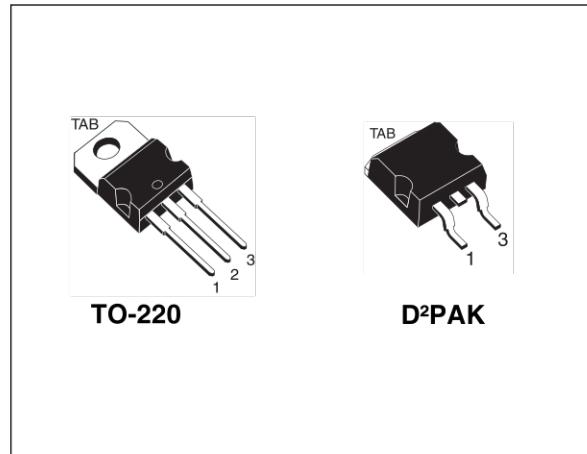
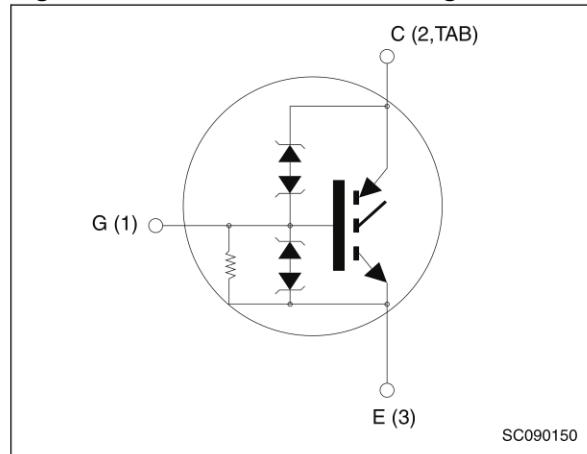
- Low threshold voltage
- Low on-voltage drop
- Low gate charge
- High current capability
- High voltage clamping feature

Applications

- Automotive ignition

Description

This IGBT utilizes the advanced PowerMESH™ process resulting in an excellent trade-off between switching performance and low on-state behavior. The built in collector-gate Zener exhibits a very precise active clamping while the gate-emitter Zener supplies an ESD protection.

**Figure 1. Internal schematic diagram**

SC090150

Table 1. Device summary

Order codes	Marking	Package	Packaging
STGB10NB37LZ	GB10NB37LZ	D²PAK	Tube
STGB10NB37LZT4	GB10NB37LZ	D²PAK	Tape and reel
STGP10NB37LZ	GP10NB37LZ	TO-220	Tube

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1 Electrical ratings

Table 2. Absolute maximum ratings

Symbol	Parameter	Value	Unit
V_{CES}	Collector-emitter voltage ($V_{GE} = 0$)	V_{CES} (clamped)	V
V_{ECS}	Emitter collector voltage ($V_{GE} = 0$)	18	V
$I_C^{(1)}$	Collector current (continuous) at $T_C = 25^\circ\text{C}$	20	A
$I_C^{(1)}$	Collector current (continuous) at $T_C = 100^\circ\text{C}$	10	A
$I_{CP}^{(2)}$	Pulsed collector current	40	A
$I_{CL}^{(3)}$	Turn-off latching current	40	A
V_{GE}	Gate-emitter voltage	V_{GE} (clamped)	V
P_{TOT}	Total dissipation at $T_C = 25^\circ\text{C}$	125	W
ESD(HBM)	Electrostatic sensitive discharge, human body model applied to all three pins ($C=100\text{ pF}, R=1.5\text{ k}\Omega$)	4	kV
E_{AS}	Single pulse energy at $T_C = 25^\circ\text{C}$	300	mJ
T_{stg}	Storage temperature	– 65 to 175	$^\circ\text{C}$
T_j	Operating junction temperature		

1. Calculated according to the iterative formula:

$$I_C(T_C) = \frac{T_{j(\max)} - T_C}{R_{thj-c} \times V_{CE(sat)(\max)}(T_{j(\max)}, I_C(T_C))}$$

2. Pulse width limited by maximum junction temperature and turn-off within RBSOA
 3. $V_{clamp} = 328\text{ V}, T_C = 125^\circ\text{C}, R_G=1\text{ k}\Omega, V_{GE}=5\text{ V}$

Table 3. Thermal data

Symbol	Parameter	Value	Unit
$R_{thj-case}$	Thermal resistance junction-case	1.2	$^\circ\text{C/W}$
$R_{thj-amb}$	Thermal resistance junction-ambient	62.5	$^\circ\text{C/W}$

2 Electrical characteristics

($T_J = 25^\circ\text{C}$ unless otherwise specified)

Table 4. Static

Symbol	Parameter	Test conditions	Min.	Typ.	Max.	Unit
$V_{CES(\text{clamped})}$	Collector emitter clamped voltage ($V_{GE} = 0$)	$I_C = 2 \text{ mA}$, $T_J = -40^\circ\text{C}$ to 150°C	380	410	440	V
$V_{(\text{BR})\text{ECS}}$	Emitter collector breakdown voltage ($V_{GE} = 0$)	$I_{EC} = 75 \text{ mA}$	18			V
$V_{GE(\text{clamped})}$	Gate emitter clamped voltage	$I_G = \pm 2 \text{ mA}$	12		16	V
$V_{CE(\text{sat})}$	Collector-emitter saturation voltage	$V_{GE} = 4.5 \text{ V}$, $I_C = 10 \text{ A}$ $V_{GE} = 4.5 \text{ V}$, $I_C = 20 \text{ A}$		1.2 1.3	1.8	V V
$V_{GE(\text{th})}$	Gate threshold voltage	$V_{CE} = V_{GE}$, $I_C = 250 \mu\text{A}$ $T_J = -40^\circ\text{C}$ to 150°C	0.6		2.2	V
I_{CES}	Collector cut-off current ($V_{GE} = 0$)	$V_{CE} = 15 \text{ V}$, $T_J = 150^\circ\text{C}$ $V_{CE} = 200 \text{ V}$, $T_J = 150^\circ\text{C}$			10 100	μA μA
I_{GES}	Gate-emitter leakage current ($V_{CE} = 0$)	$V_{GE} = \pm 10 \text{ V}$			± 700	μA
R_{GE}	Gate emitter resistance			20		k Ω
g_{fs}	Forward transconductance	$V_{CE} = 25 \text{ V}$, $I_C = 20 \text{ A}$		18		S

Table 5. Dynamic

Symbol	Parameter	Test conditions	Min.	Typ.	Max.	Unit
C_{ies} C_{oes} C_{res}	Input capacitance Output capacitance Reverse transfer capacitance	$V_{CE} = 25 \text{ V}$, $f = 1 \text{ MHz}$, $V_{GE} = 0$		1300 105 12		pF pF pF
Q_g	Total gate charge	$V_{CE} = 328 \text{ V}$, $I_C = 10 \text{ A}$, $V_{GE} = 5 \text{ V}$, (see Figure 18)		28		nC

Table 6. Functional characteristics

Symbol	Parameter	Test condition	Min.	Typ.	Max.	Unit
U.I.S.	Unclamped inductive switching current	$R_{GOFF} = 1 \text{ k}\Omega$, $L = 1 \text{ mH}$, $T_J = 125^\circ\text{C}$	13			A

Table 7. Switching on/off (inductive load)

Symbol	Parameter	Test conditions	Min.	Typ.	Max.	Unit
$t_{d(on)}$ t_r (di/dt) _{on}	Turn-on delay time Current rise time Turn-on current slope	$V_{CC} = 328 \text{ V}$, $I_C = 10 \text{ A}$ $R_G = 1 \text{ k}\Omega$, $V_{GE} = 5 \text{ V}$ (see Figure 19)		1300 270 60		ns ns $\text{A}/\mu\text{s}$
t_c $t_r(V_{off})$ $t_d(off)$ t_f	Cross-over time Off voltage rise time Delay time Fall time	$V_{CC} = 328 \text{ V}$, $I_C = 10 \text{ A}$ $R_G = 1 \text{ K}\Omega$, $V_{GE} = 5 \text{ V}$ (see Figure 19)		3.6 2 8 1.4		μs μs μs μs
t_c $t_r(V_{off})$ $t_d(off)$ t_f	Cross-over time Off voltage rise time Delay time Fall time	$V_{CC} = 328 \text{ V}$, $I_C = 10 \text{ A}$ $R_G = 1 \text{ k}\Omega$, $V_{GE} = 5 \text{ V}$, $T_J = 125 \text{ }^\circ\text{C}$ (see Figure 19)		5.7 2.7 9.2 2.8		μs μs μs μs

Table 8. Switching energy (inductive load)

Symbol	Parameter	Test conditions	Min.	Typ.	Max.	Unit
$E_{on}^{(1)}$ $E_{off}^{(2)}$ E_{ts}	Turn-on switching losses Turn-off switching losses Total switching losses	$V_{CC} = 328 \text{ V}$, $I_C = 10 \text{ A}$ $R_G = 1 \text{ k}\Omega$, $V_{GE} = 5 \text{ V}$ (see Figure 19)		2.4 5 7.4		mJ mJ mJ
$E_{on}^{(1)}$ $E_{off}^{(2)}$ E_{ts}	Turn-on switching losses Turn-off switching losses Total switching losses	$V_{CC} = 328 \text{ V}$, $I_C = 10 \text{ A}$ $R_G = 1 \text{ k}\Omega$, $V_{GE} = 5 \text{ V}$, $T_J = 125 \text{ }^\circ\text{C}$ (see Figure 19)		2.6 8.7 11.3		mJ mJ mJ

1. E_{on} is the turn-on losses when a typical diode is used in the test circuit in figure 2. If the IGBT is offered in a package with a co-pak diode, the co-pak diode is used as external diode. IGBTs & Diode are at the same temperature ($25 \text{ }^\circ\text{C}$ and $125 \text{ }^\circ\text{C}$)
2. Turn-off losses include also the tail of the collector current

2.1 Electrical characteristics (curves)

Figure 2. Output characteristics

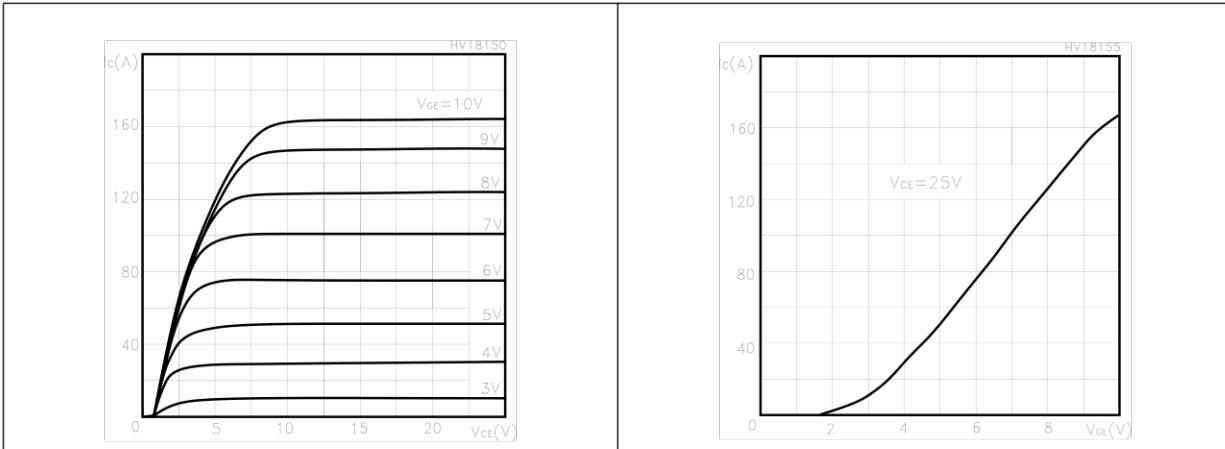


Figure 4. Transconductance

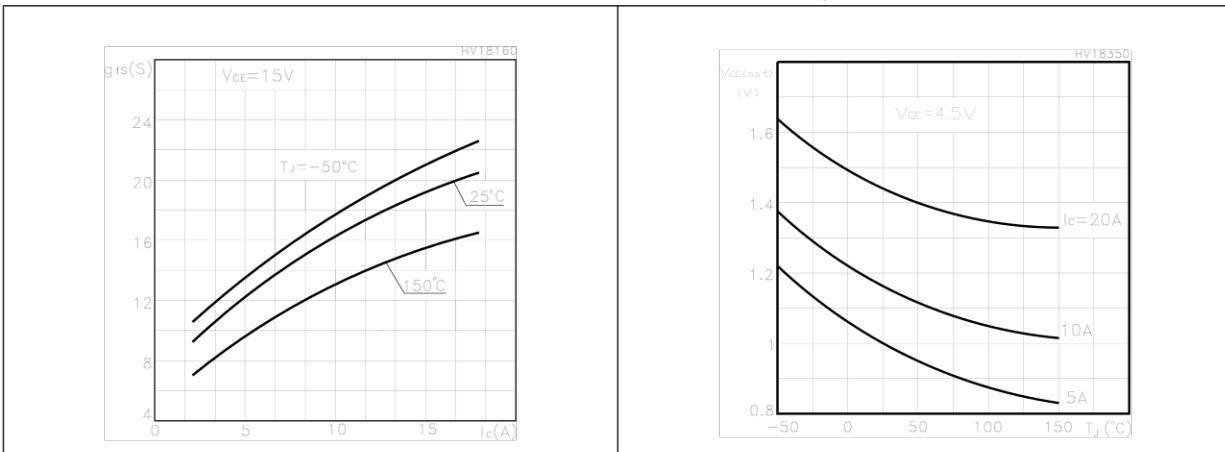


Figure 3. Transfer characteristics

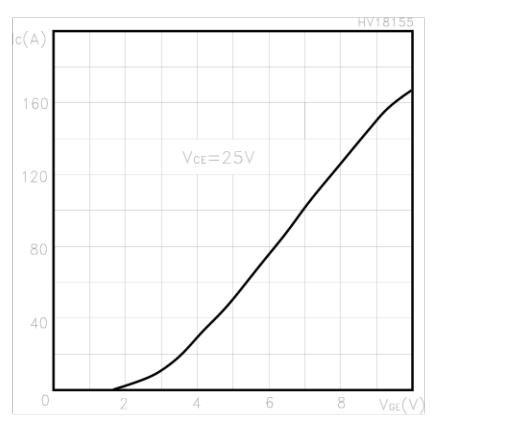


Figure 5. Collector-emitter on voltage vs temperature

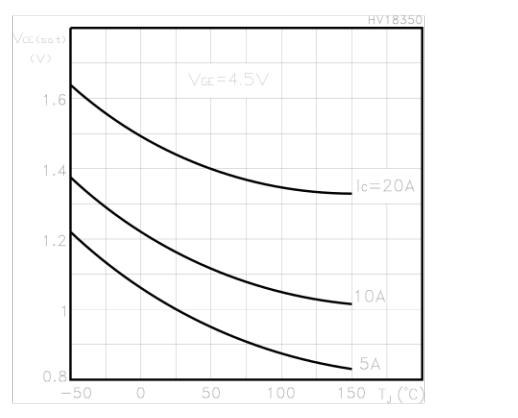


Figure 6. Gate charge vs gate-source voltage

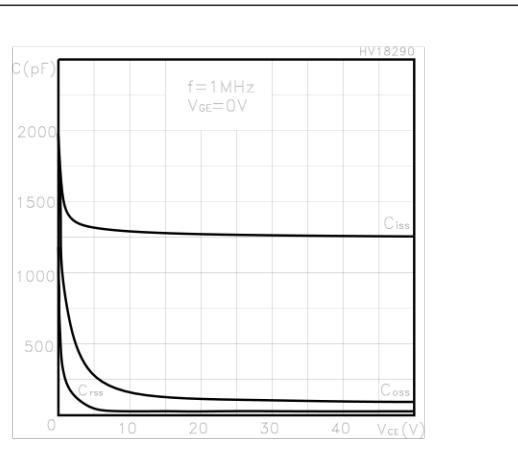
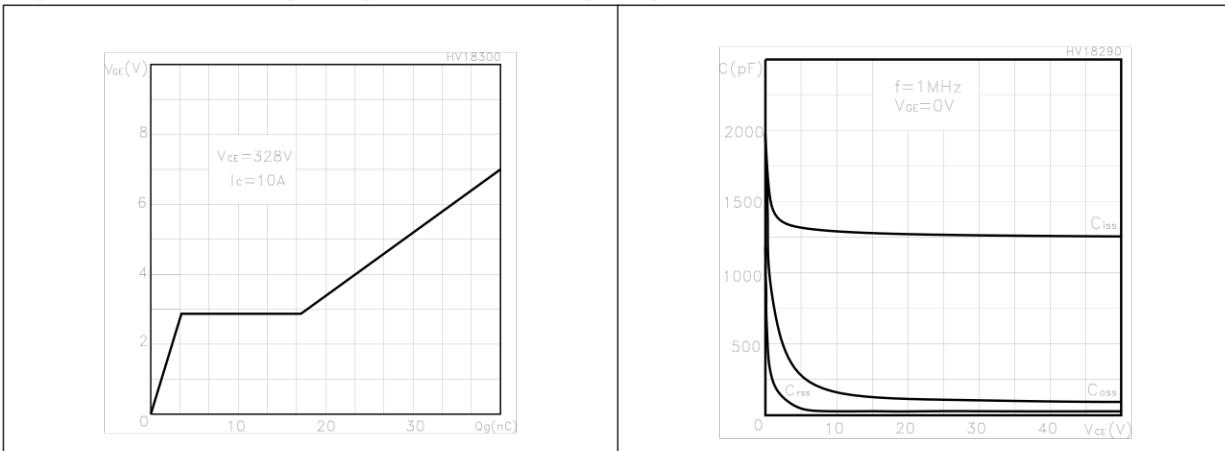


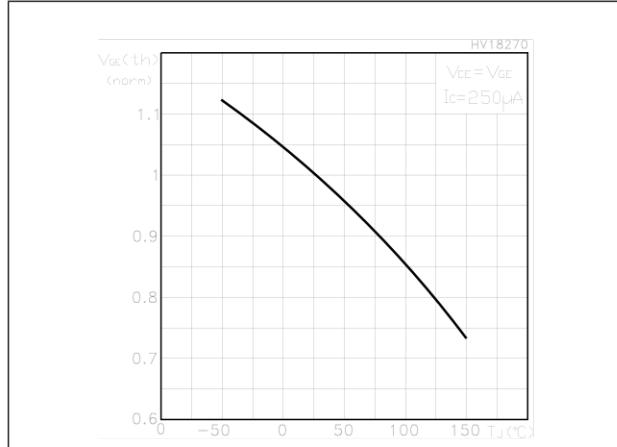
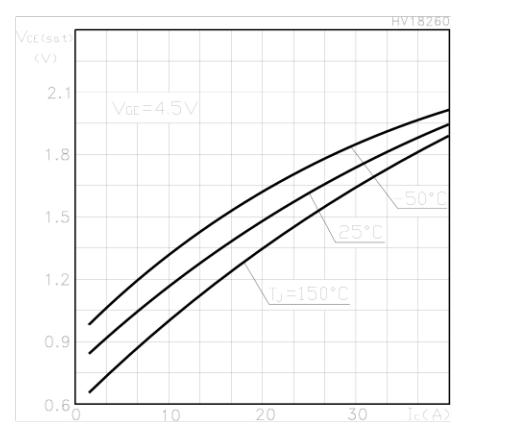
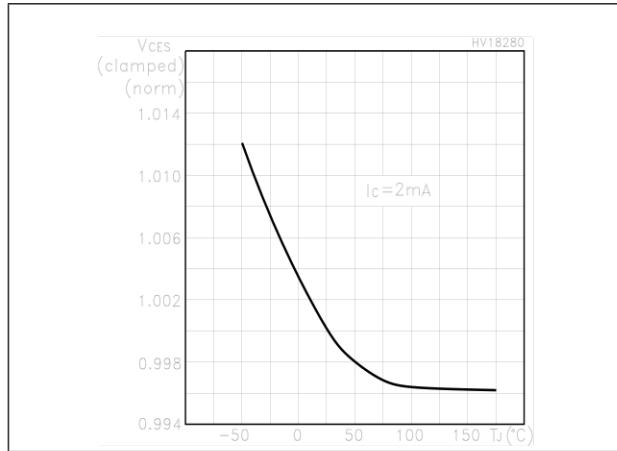
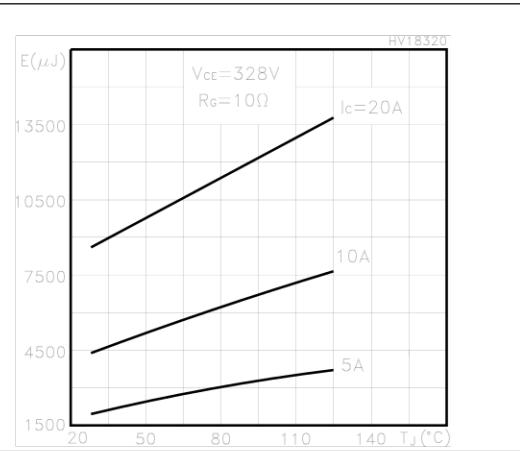
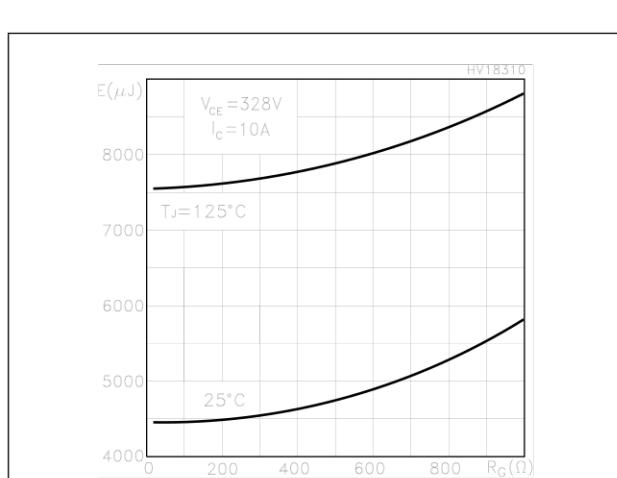
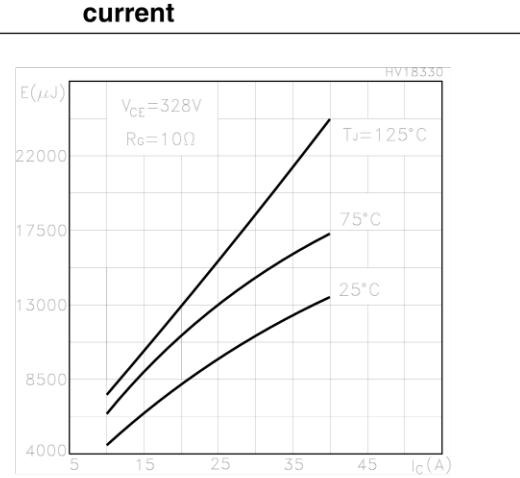
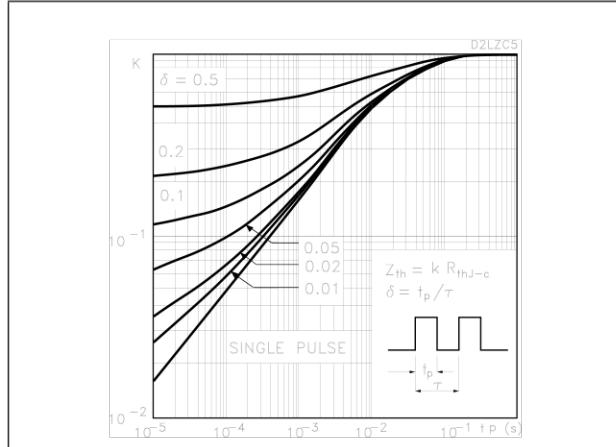
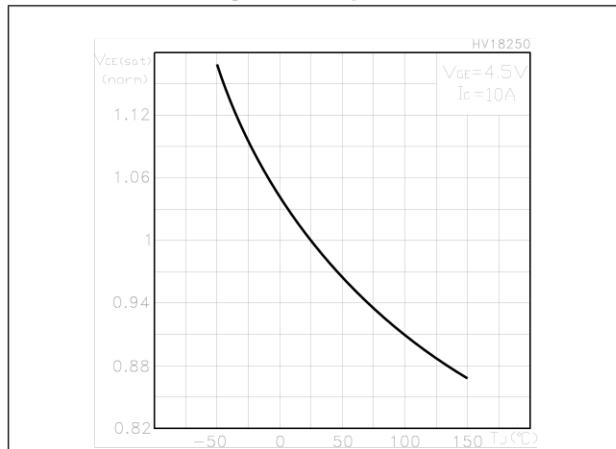
Figure 8. Normalized gate threshold voltage vs temperature**Figure 9. Collector-emitter on voltage vs collector current****Figure 10. Normalized clamping voltage vs temperature****Figure 11. Switching losses vs temperature****Figure 12. Switching losses vs gate resistance****Figure 13. Switching losses vs collector current**

Figure 14. Thermal impedance**Figure 15. Turn-off SOA****Figure 16. Normalized collector-emitter on voltage vs temperature**

3 Test circuits

Figure 17. Test circuit for inductive load switching

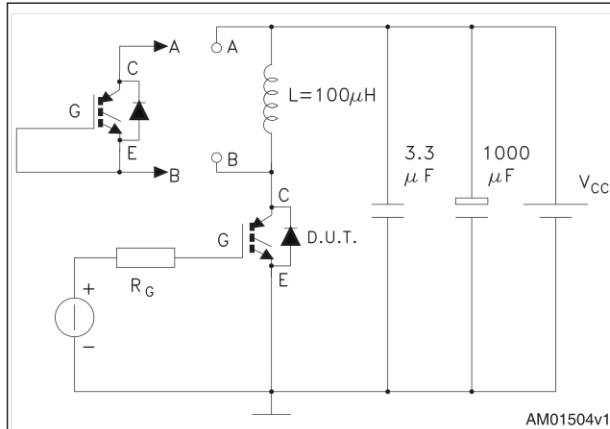


Figure 18. Gate charge test circuit

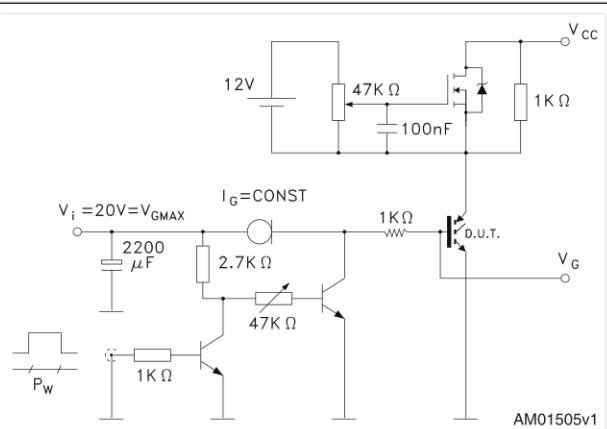
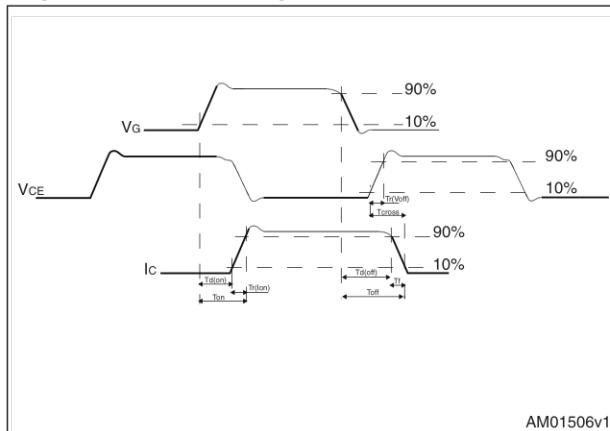


Figure 19. Switching waveform

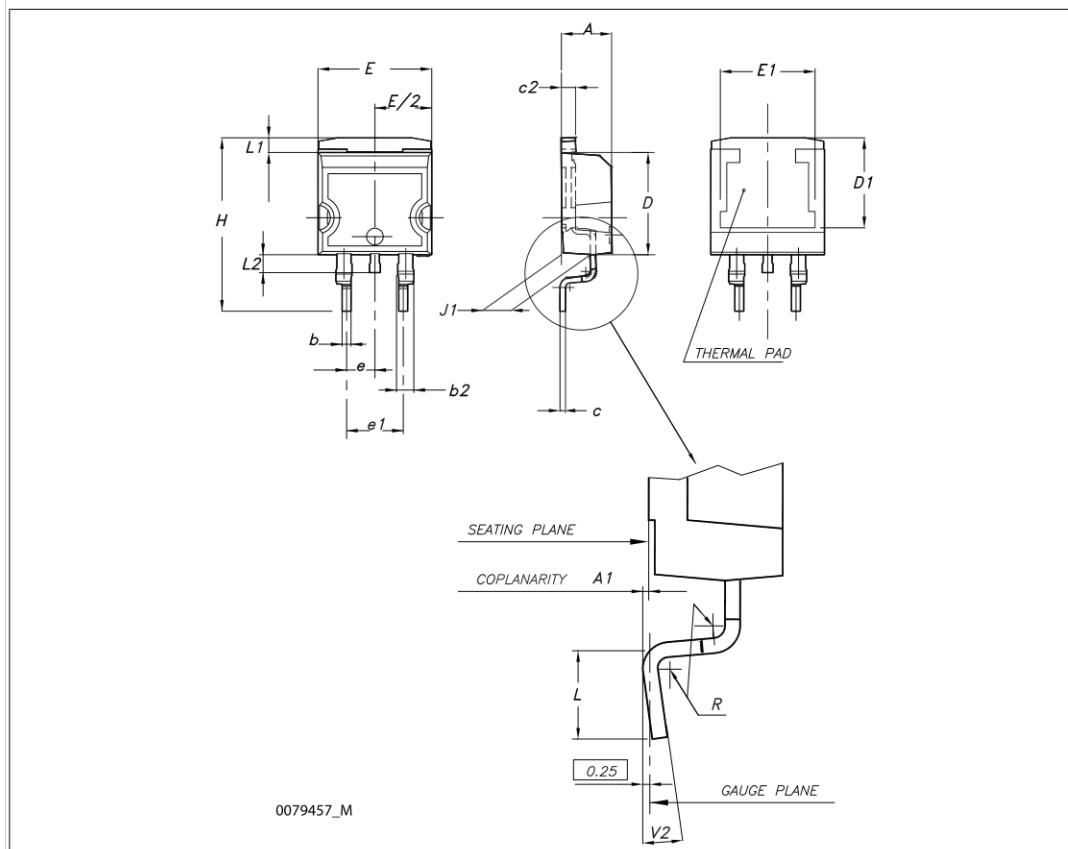


4 Package mechanical data

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK® packages, depending on their level of environmental compliance. ECOPACK® specifications, grade definitions and product status are available at: www.st.com. ECOPACK is an ST trademark.

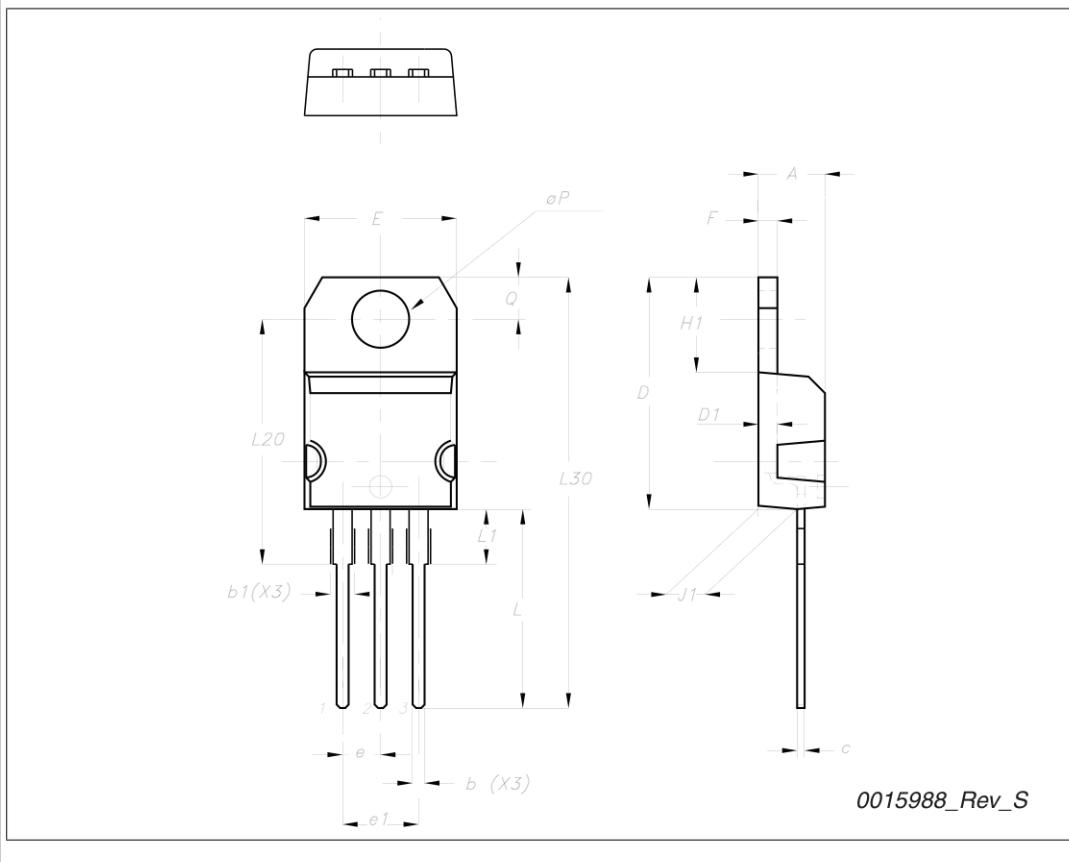
D²PAK (TO-263) mechanical data

Dim	mm			inch		
	Min	Typ	Max	Min	Typ	Max
A	4.40		4.60	0.173		0.181
A1	0.03		0.23	0.001		0.009
b	0.70		0.93	0.027		0.037
b2	1.14		1.70	0.045		0.067
c	0.45		0.60	0.017		0.024
c2	1.23		1.36	0.048		0.053
D	8.95		9.35	0.352		0.368
D1	7.50			0.295		
E	10		10.40	0.394		0.409
E1	8.50			0.334		
e		2.54			0.1	
e1	4.88		5.28	0.192		0.208
H	15		15.85	0.590		0.624
J1	2.49		2.69	0.099		0.106
L	2.29		2.79	0.090		0.110
L1	1.27		1.40	0.05		0.055
L2	1.30		1.75	0.051		0.069
R		0.4			0.016	
V2	0°		8°	0°		8°

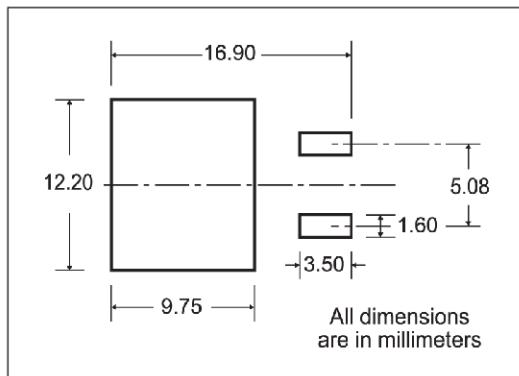


TO-220 type A mechanical data

Dim	mm		
	Min	Typ	Max
A	4.40		4.60
b	0.61		0.88
b1	1.14		1.70
c	0.48		0.70
D	15.25		15.75
D1		1.27	
E	10		10.40
e	2.40		2.70
e1	4.95		5.15
F	1.23		1.32
H1	6.20		6.60
J1	2.40		2.72
L	13		14
L1	3.50		3.93
L20		16.40	
L30		28.90	
ØP	3.75		3.85
Q	2.65		2.95



5 Packaging mechanical data

D²PAK FOOTPRINT

TAPE AND REEL SHIPMENT

REEL MECHANICAL DATA				
DIM.	mm MIN.	mm MAX.	inch MIN.	inch MAX.
A			330	12.992
B	1.5		0.059	
C	12.8	13.2	0.504	0.520
D	20.2		0795	
G	24.4	26.4	0.960	1.039
N	100		3.937	
T		30.4		1.197

BASE QTY	BULK QTY
1000	1000

TAPE MECHANICAL DATA

DIM.	mm		inch	
	MIN.	MAX.	MIN.	MAX.
A0	10.5	10.7	0.413	0.421
B0	15.7	15.9	0.618	0.626
D	1.5	1.6	0.059	0.063
D1	1.59	1.61	0.062	0.063
E	1.65	1.85	0.065	0.073
F	11.4	11.6	0.449	0.456
K0	4.8	5.0	0.189	0.197
P0	3.9	4.1	0.153	0.161
P1	11.9	12.1	0.468	0.476
P2	1.9	2.1	0.075	0.082
R	50		1.574	
T	0.25	0.35	0.0098	0.0137
W	23.7	24.3	0.933	0.956

40 mm min. Access hole at slot location

Full radius

Tape slot in core for tape start 2.5mm min. width

10 pitches cumulative tolerance on tape +/- 0.2 mm

Center line of cavity

User Direction of Feed

FEED DIRECTION →

Bending radius R min.

6 Revision history

Table 9. Document revision history

Date	Revision	Changes
23-Jan-2006	2	
11-Feb-2009	3	Added new package, mechanical data TO-220
06-Nov-2009	4	TO-220 mechanical data has been updated.

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